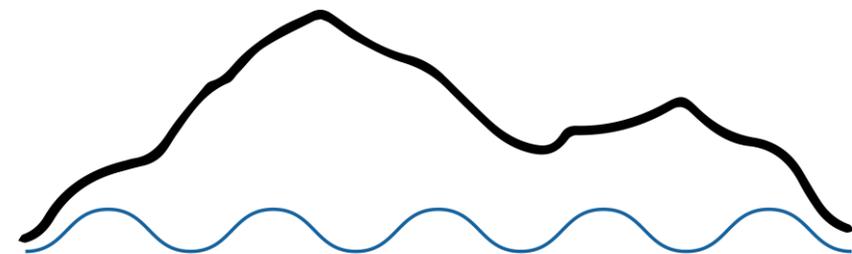


Studies on remoTES-based Cryogenic Calorimeters for the COSINUS Experiment

IMPRS Recruitment Workshop, 12.07.2023
Speaker: Kumrie Shera

MAX-PLANCK-INSTITUT
FÜR PHYSIK

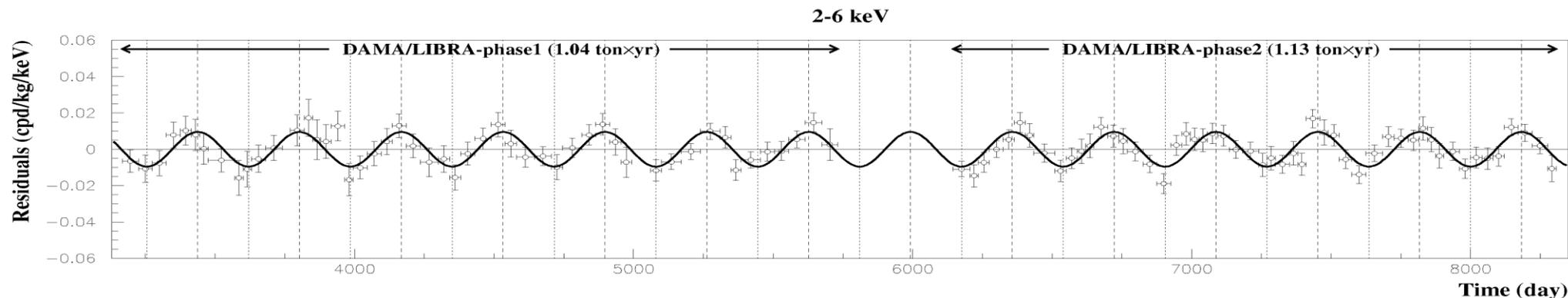


COSINUS

Cryogenic Observatory for Signals seen in Next Underground Searches (COSINUS)

- Direct dark matter search operating NaI as a cryogenic calorimeter
- Primary objective: a model-independent cross-check of the modulation signal observed by the DAMA/LIBRA experiment

<https://iopscience.iop.org/article/10.1088/1475-7516/2018/05/074/pdf>



DOI:10.3390/universe4110116

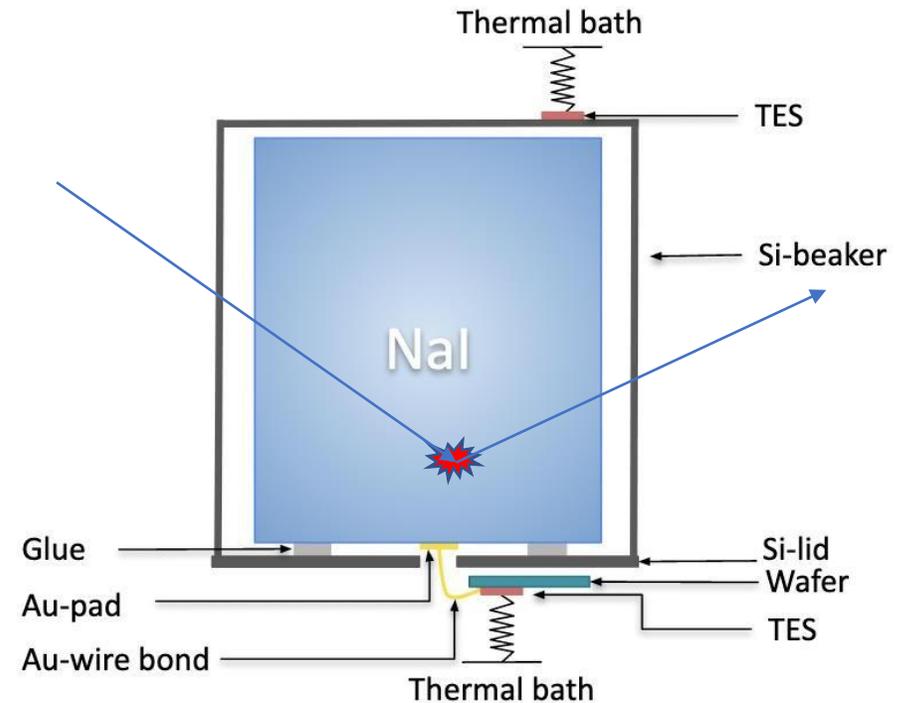
COSINUS cryogenic detector module

Phonon signal + Light signal: dual channel readout technique

→ particle identification on an event-by-event basis

→ background discrimination

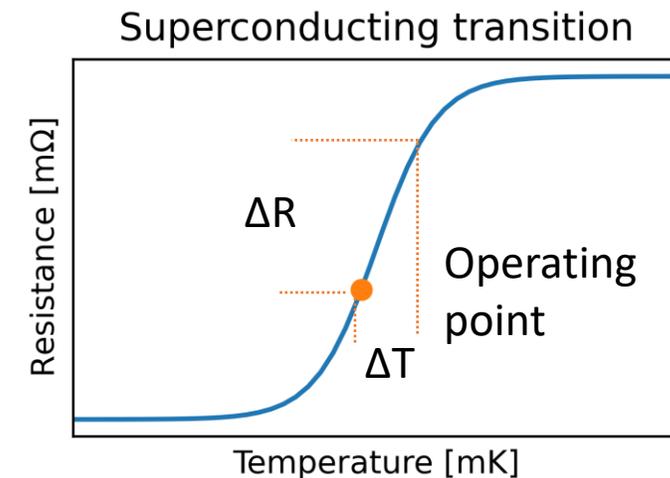
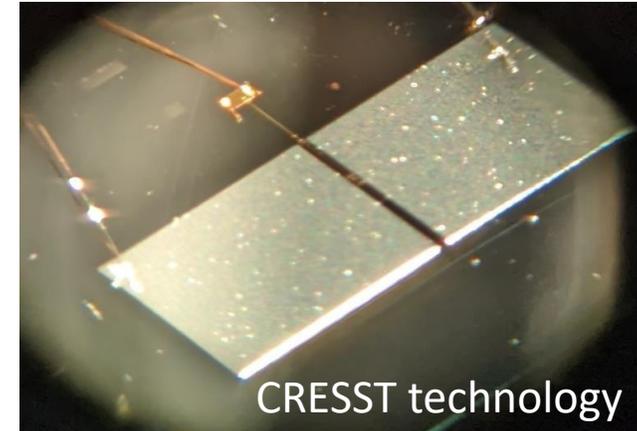
→ clarification of the modulation signal observed by DAMA/LIBRA



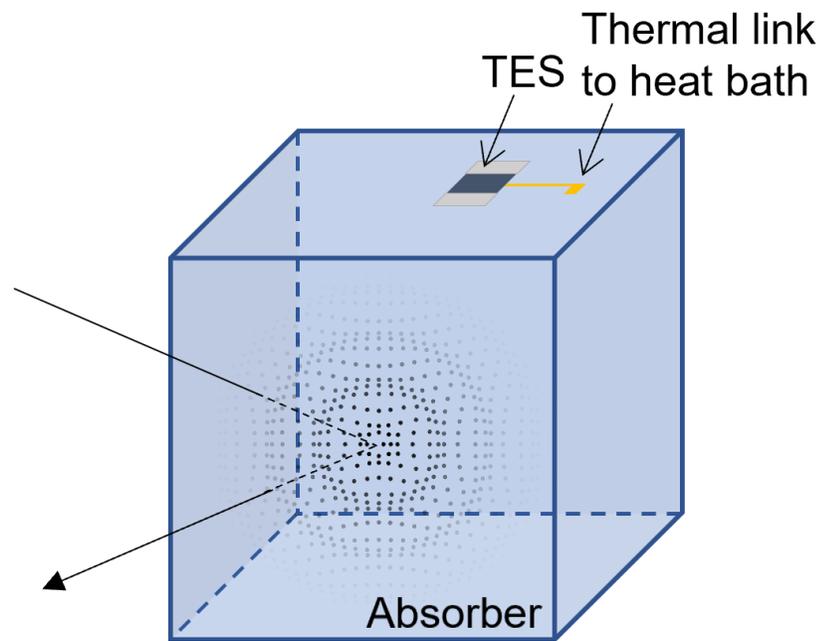
Transition Edge Sensor (TES)

Phonon channel + **Light channel**: readout with Transition Edge Sensors

- Sensors made of superconducting tungsten thin film ($T_c = 15$ mK)
- Operated in the transition between the normal conducting and the superconducting phase
- Small increase in the temperature $\mathcal{O}(\mu\text{K})$ leads to a change in the resistance $\mathcal{O}(\text{m}\Omega)$



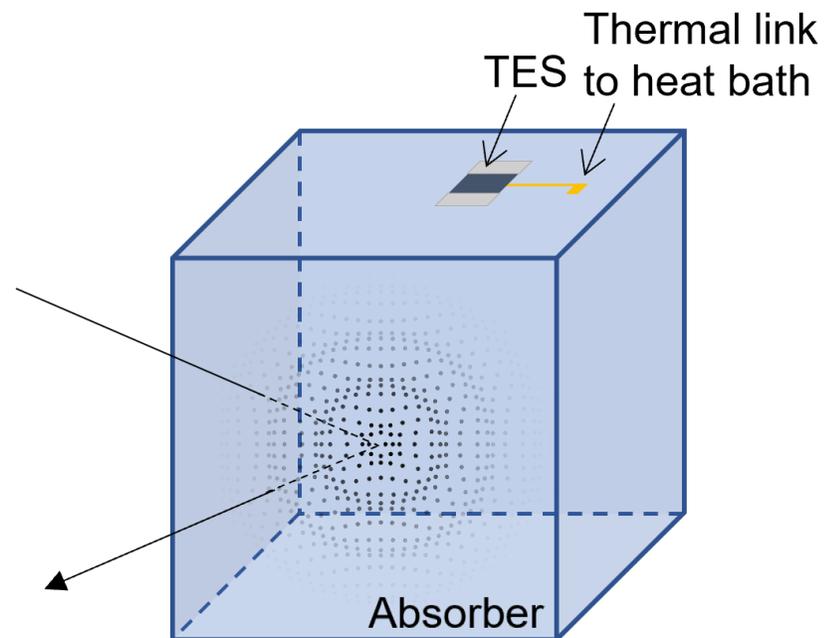
TES



TES and NaI

NaI:

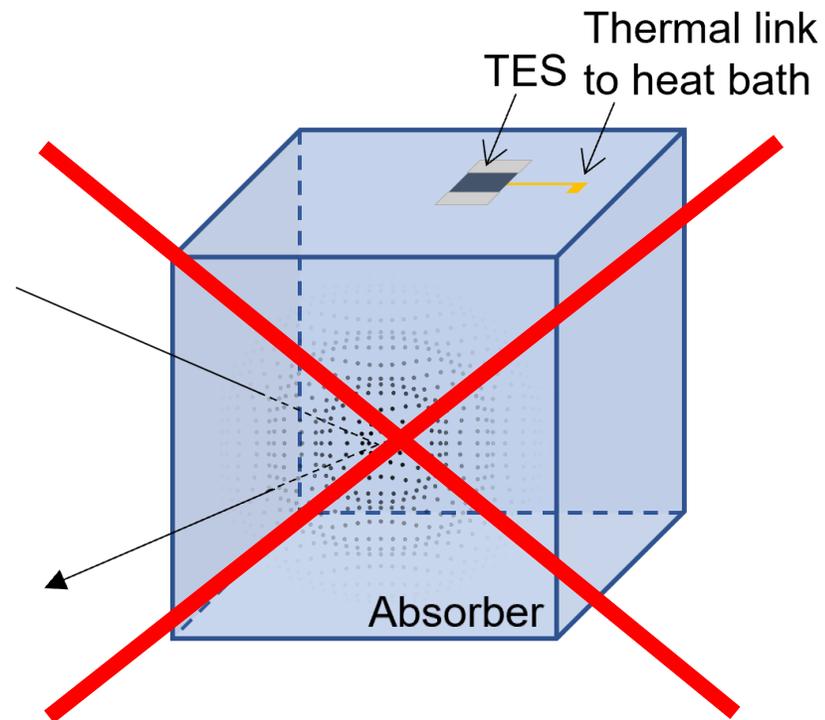
- hygroscopic
- soft
- low melting point (662 °C)



TES and NaI

NaI:

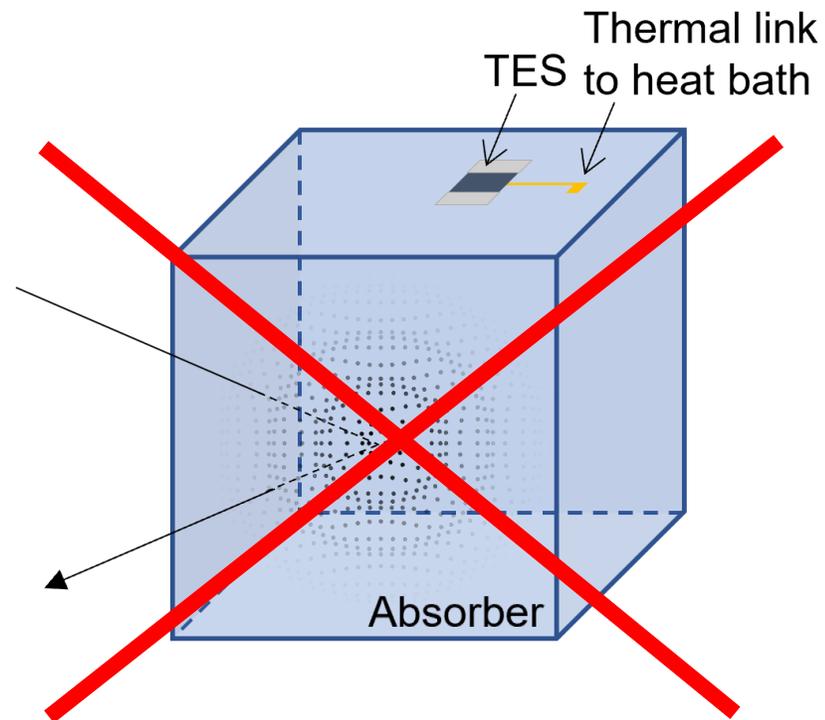
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TES and NaI

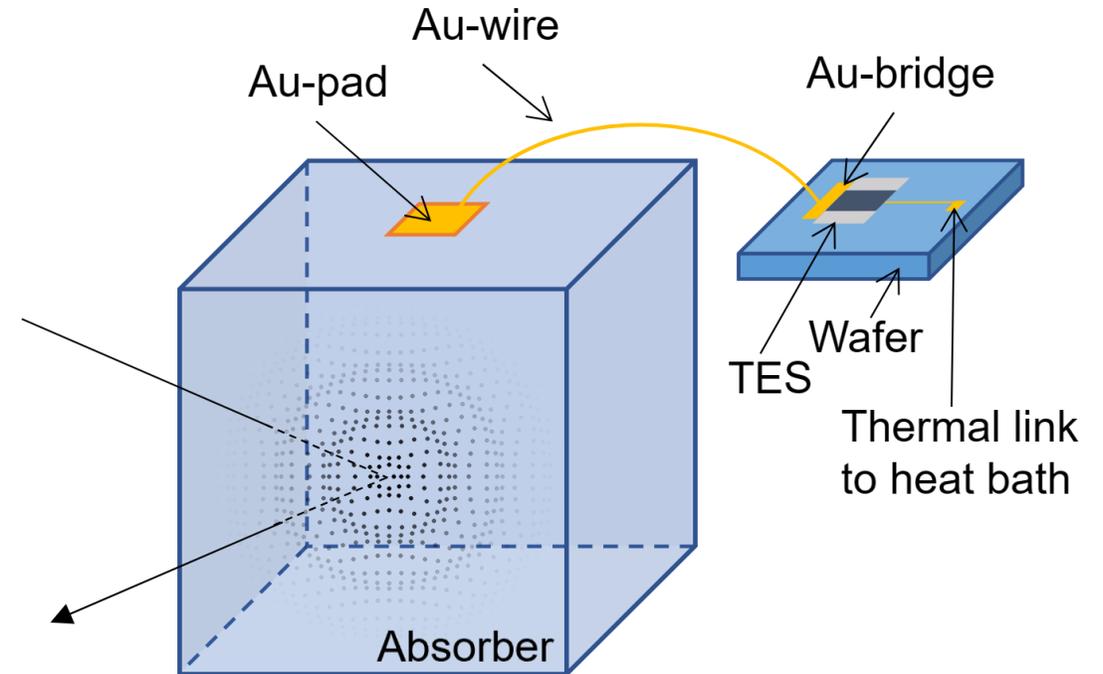
NaI:

- hygroscopic
- soft
- low melting point (662 °C)



remoTES

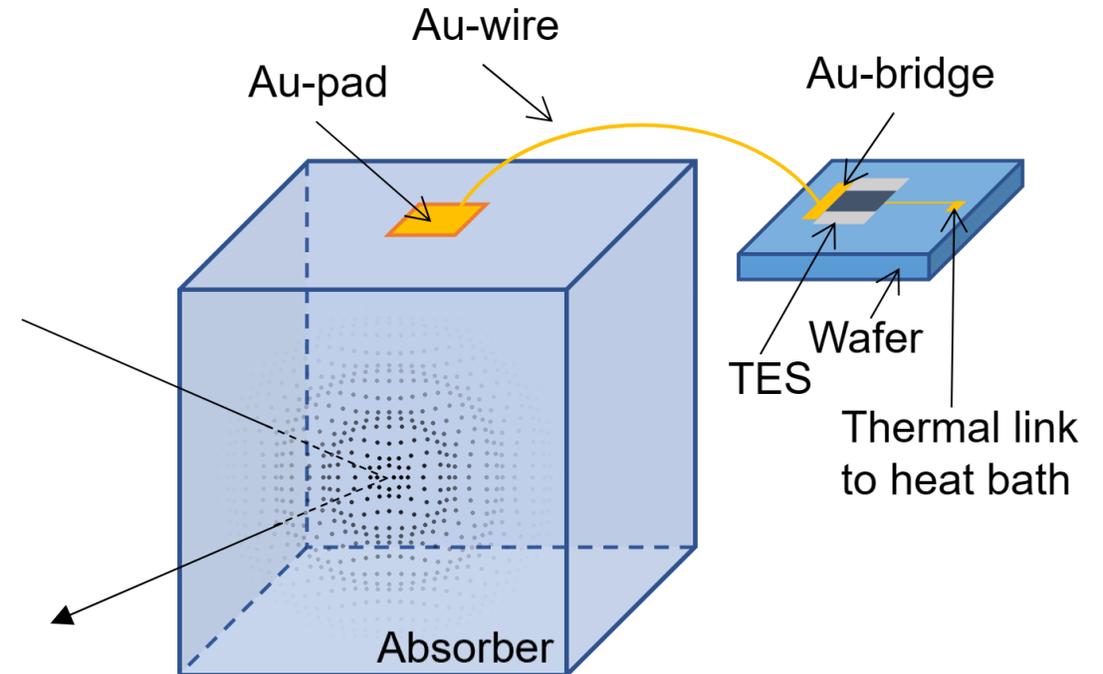
- TES deposited on a separate wafer
[arXiv:1503.01200](https://arxiv.org/abs/1503.01200)



<https://doi.org/10.1016/j.nima.2022.167532>

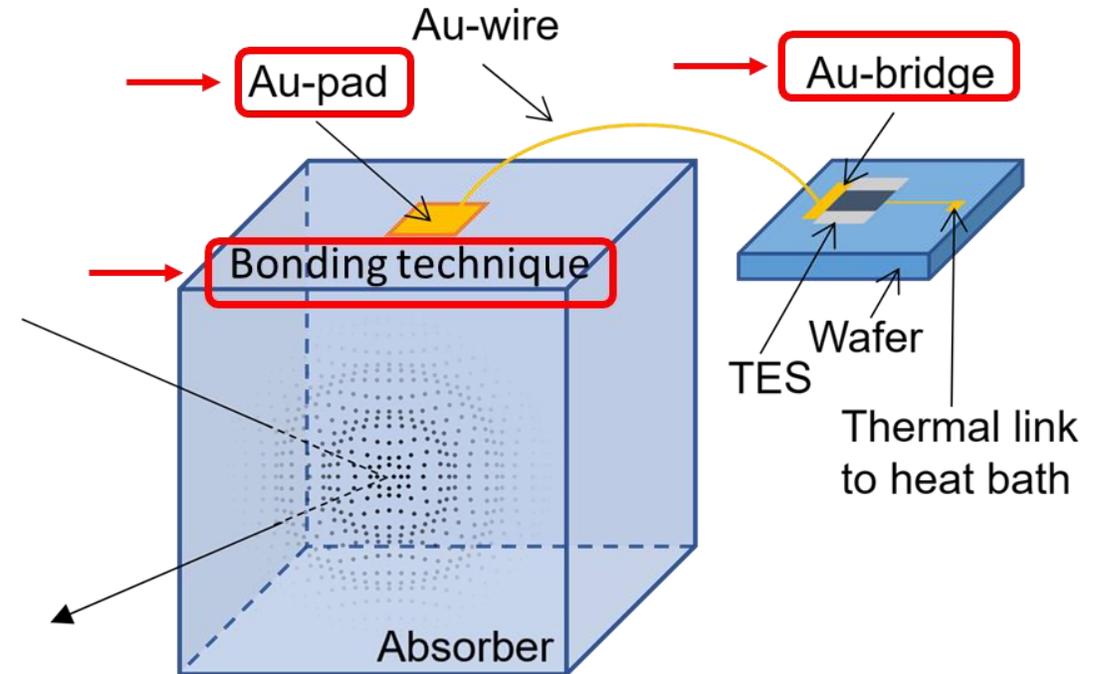
Motivation for my work

- remoTES readout design crucial for COSINUS to achieve a threshold of 1 keV
- remoTES is a composite design
- goal: study systematically the impact of the different components on the overall performance

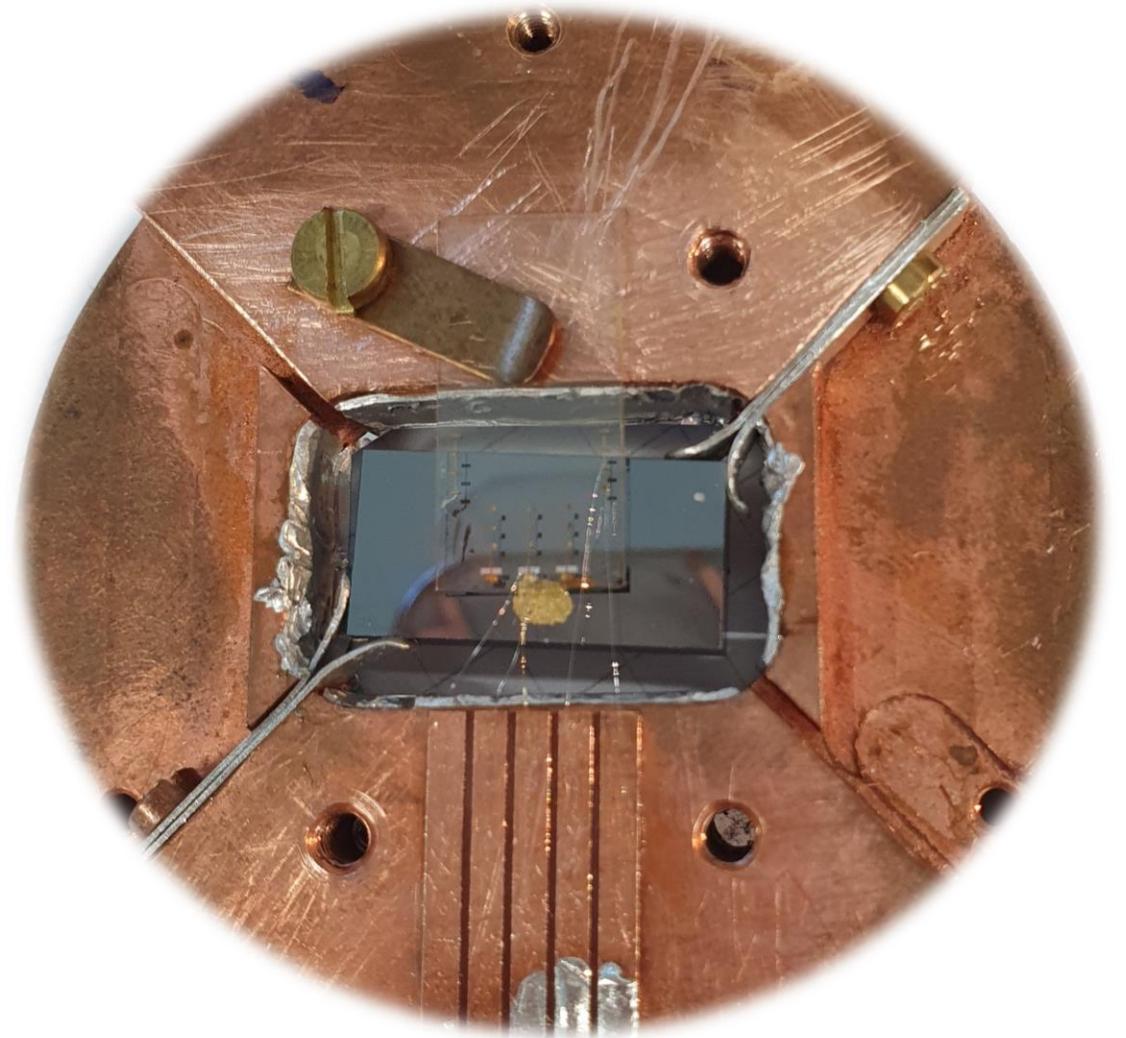


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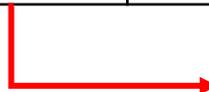


Systematic studies on silicon(Si) remoTES cryogenic calorimeters



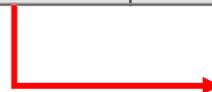
Overview

Overview of the different detector setups				
Run	Detector	Au-pad thickness	Bonding technique	Au-bridge/Au-island
Run233	Ψ	1 μm (glued)	Wedge-bond	Au-bridge
	Φ	1 μm (glued)	Wedge-bond	Au-bridge
Run595	Electra	200 nm (sputtered)	Ball-bond	Au-bridge
	Olympia	8 μm (glued)	Ball-bond	Au-bridge
Run596	Electra'	200 nm (sputtered)	Second ball-bond	Au-bridge
	Olympia'	8 μm (glued)	Ball-bond	Au-island

 CRESST R&D facility at MPP

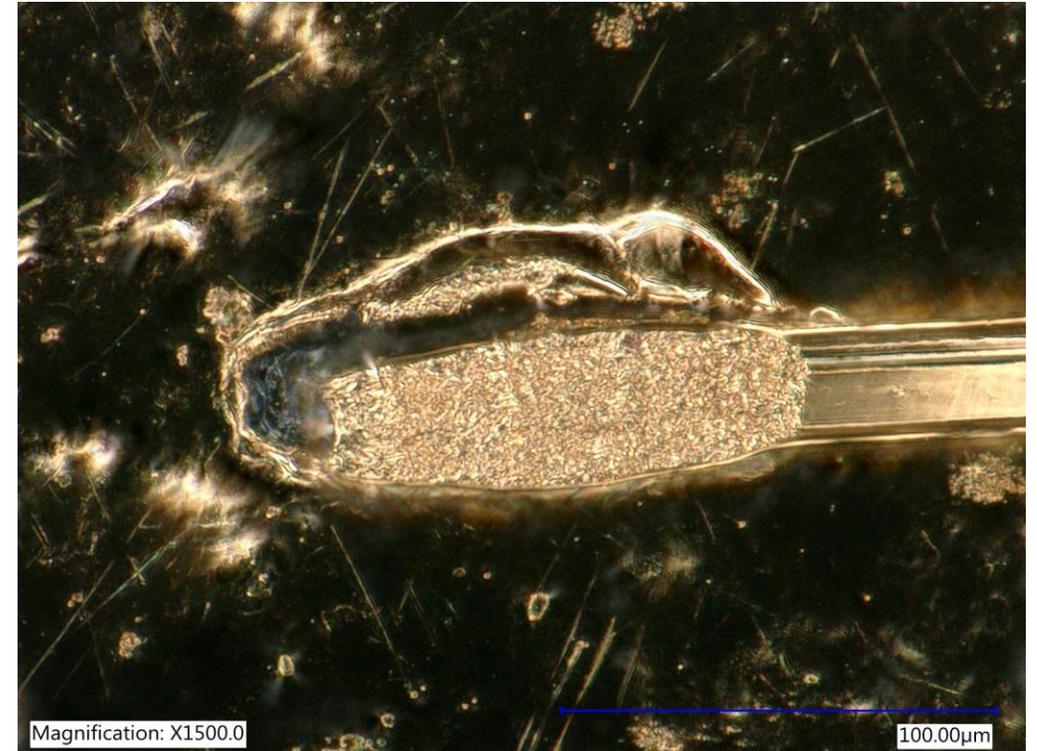
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 CRESST R&D facility at MPP

Wedge-bond on 1 μm thick Au-foil

- The wedge bonding foot breaks the Au-pad
→ limitation of the surface area of the Au-pad available for phonon collection
- Wedge bond might be a bottleneck for signal transmission
- Microfractures are produced in the NaI crystal below the bond foot



Picture was taken in cooperation with
Miriam Modjesch (MPP)

Ball-bond

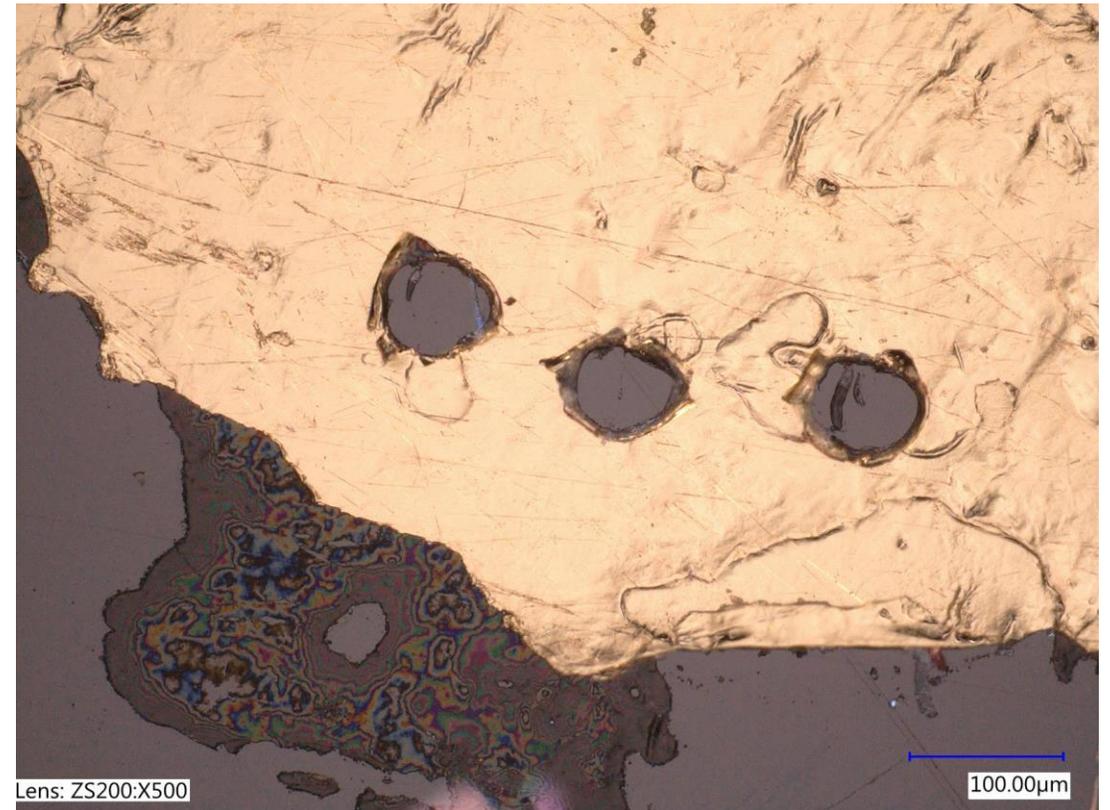
Pro:

- Less bonding force → less destructive for Au-pad and crystal (important for NaI)
- Might enable better signal transmission

Ball-bond on 1 μm thick glued Au-foil

Pro:

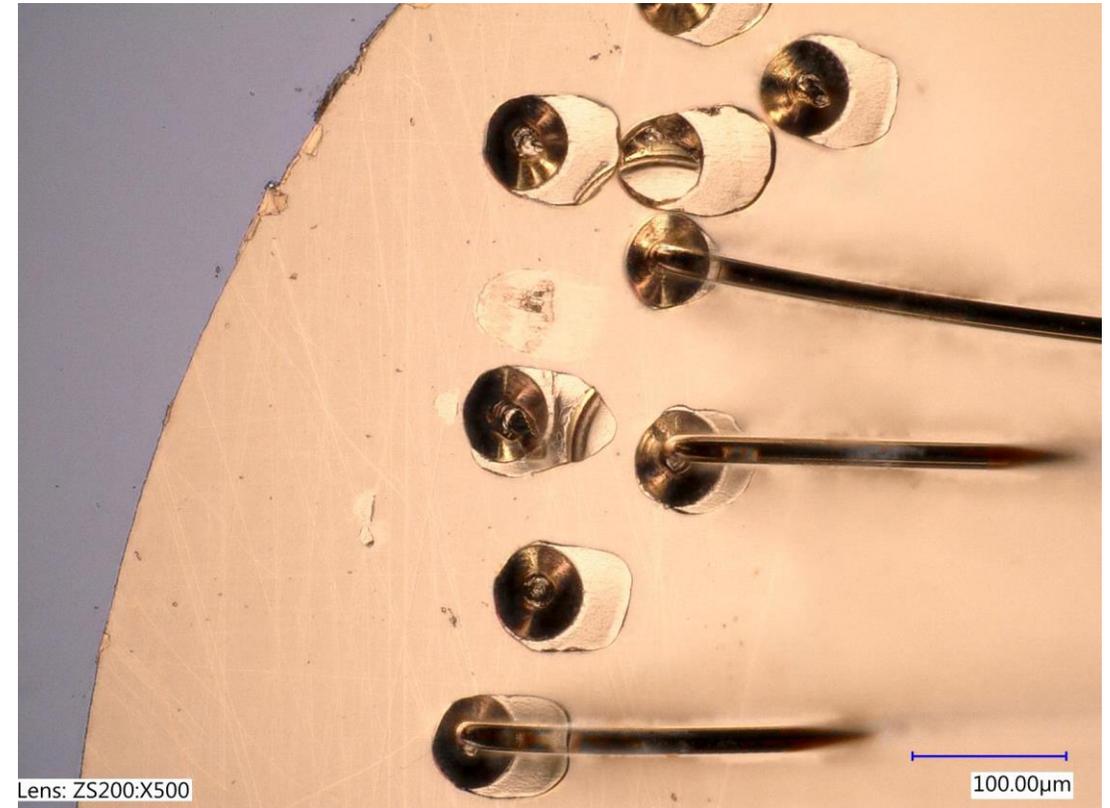
- Less bonding force \rightarrow less destructive for Au-pad and crystal (important for NaI)
- Might enable better signal transmission



Ball-bond on 200 nm thick sputtered Au-film

Pro:

- Less bonding force → less destructive for Au-pad and crystal (important for NaI)
- Might enable better signal transmission

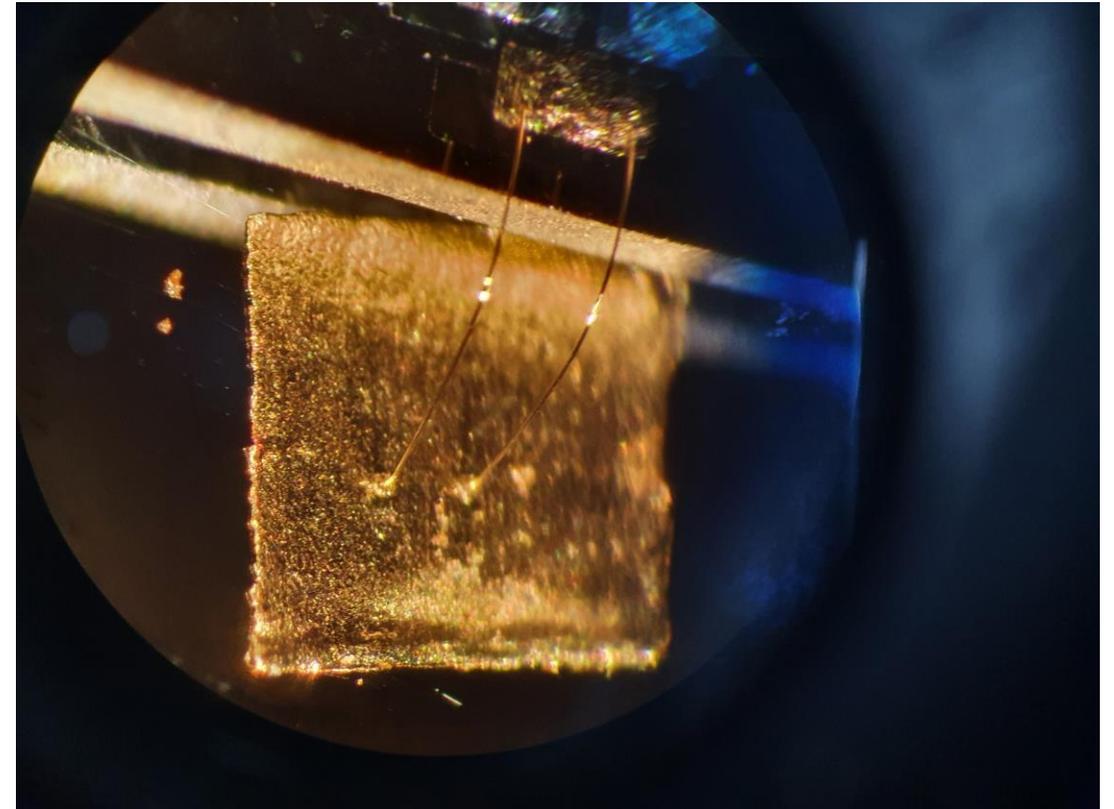


Ball-bonds were performed by **Carina Schlammer (MPP)**

Ball-bond on 8 μm thick glued Au-foil

Pro:

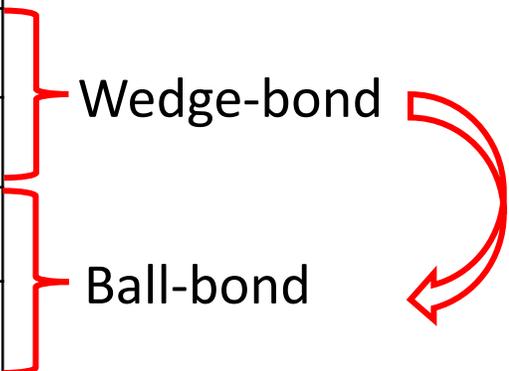
- Less bonding force \rightarrow less destructive for Au-pad and crystal (important for NaI)
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Performance comparison

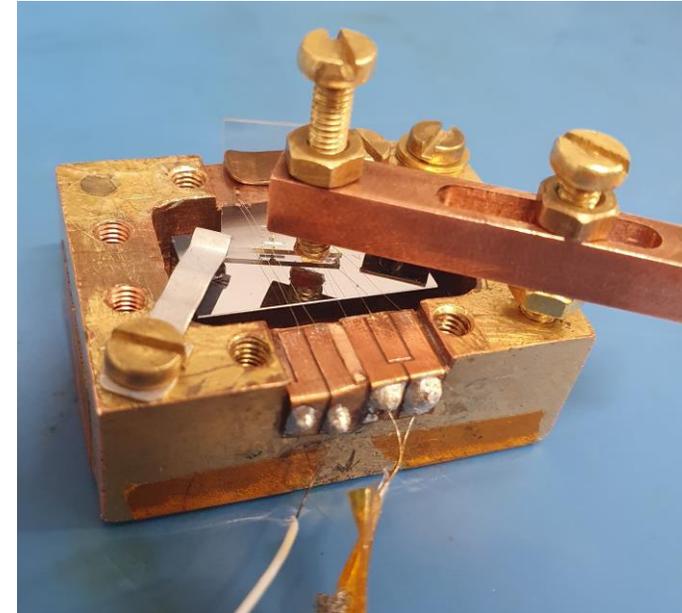
Detector	Au-pad	Baseline resolution (eV)	
Ψ	1 μm	280 \pm 9	Wedge-bond
Φ	1 μm	440 \pm 13	
Electra	200 nm	133 \pm 3	Ball-bond
Olympia	8 μm	89\pm2	
Electra'	200 nm	167 \pm 8	
Olympia'	8 μm	1159 \pm 134	



Olympia: best performance \rightarrow heat capacity not the limiting factor

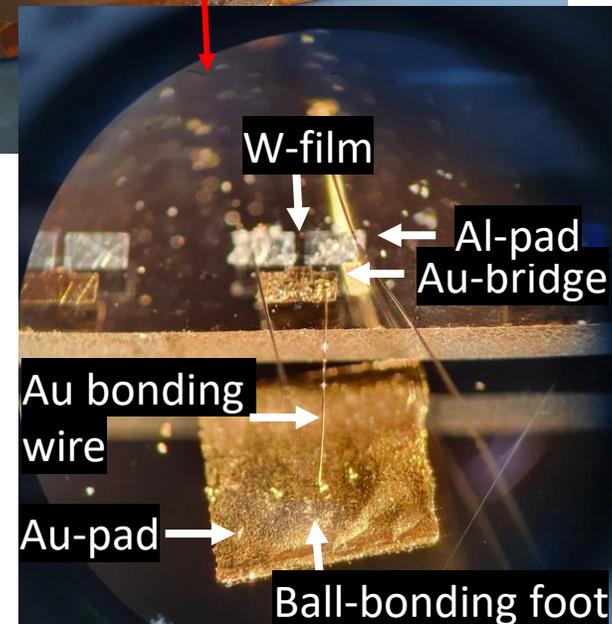
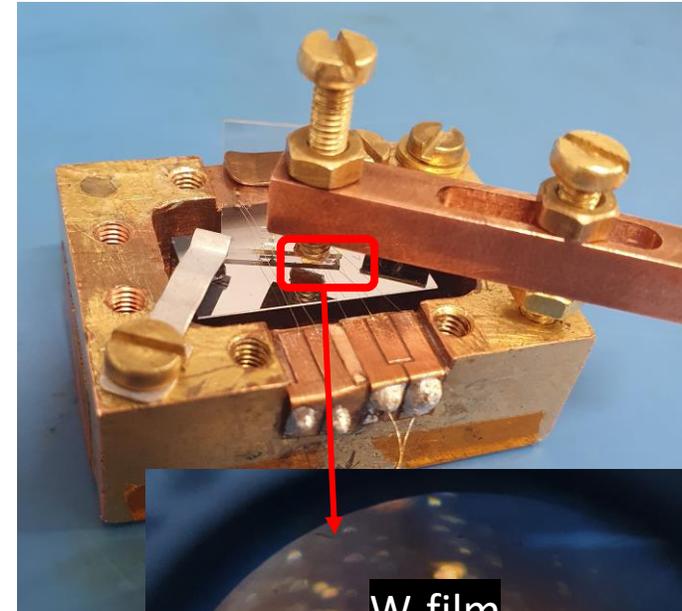
Detector Olympia

Detector	Olympia
Absorber	Si (20×10×5) mm ³
Au-pad	8 μm thickness
Au-wire	25 μm
Bonding technique	Ball-bond
TES	W-TES on Al ₂ O ₃
Calibration sources	⁵⁵ Fe

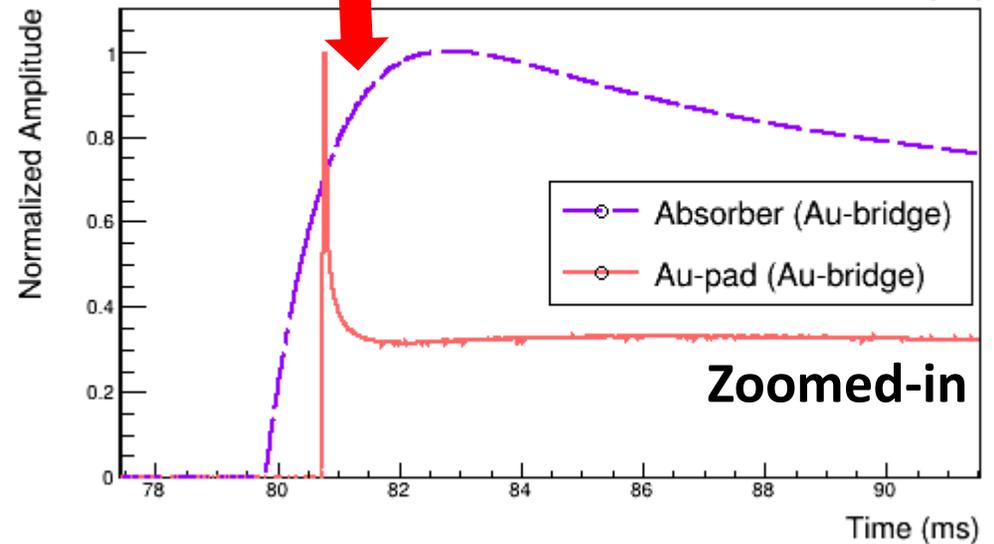
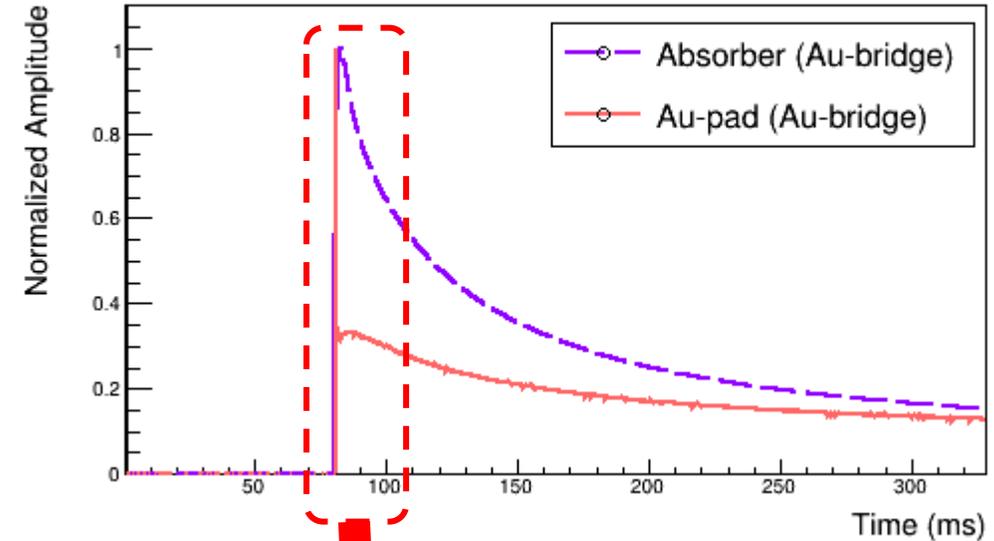
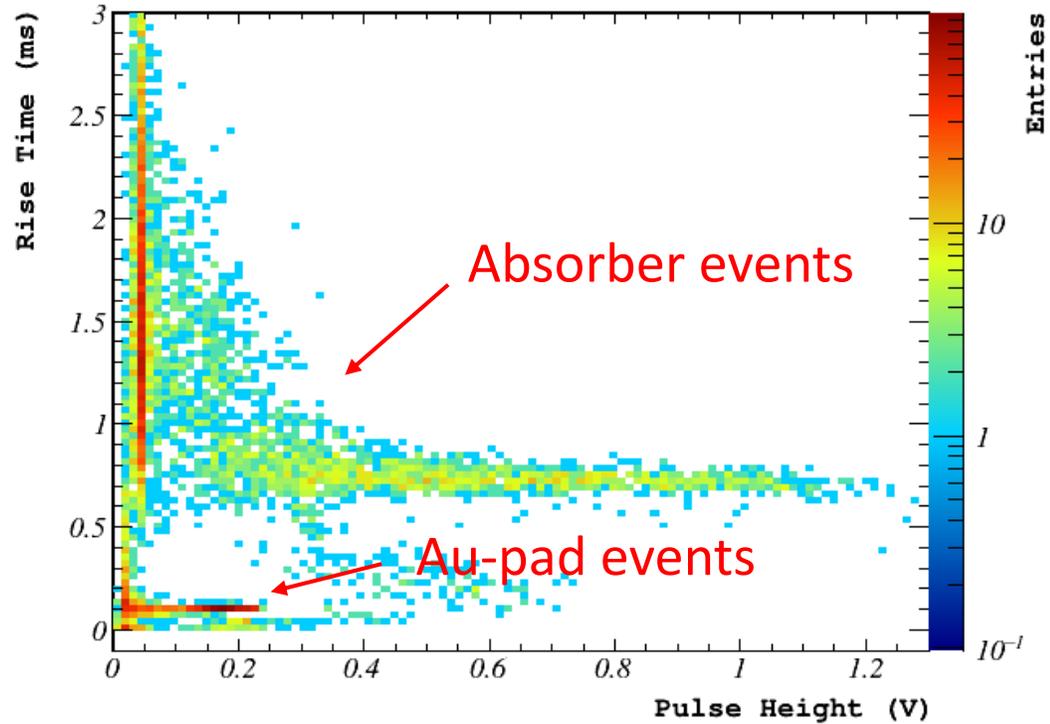


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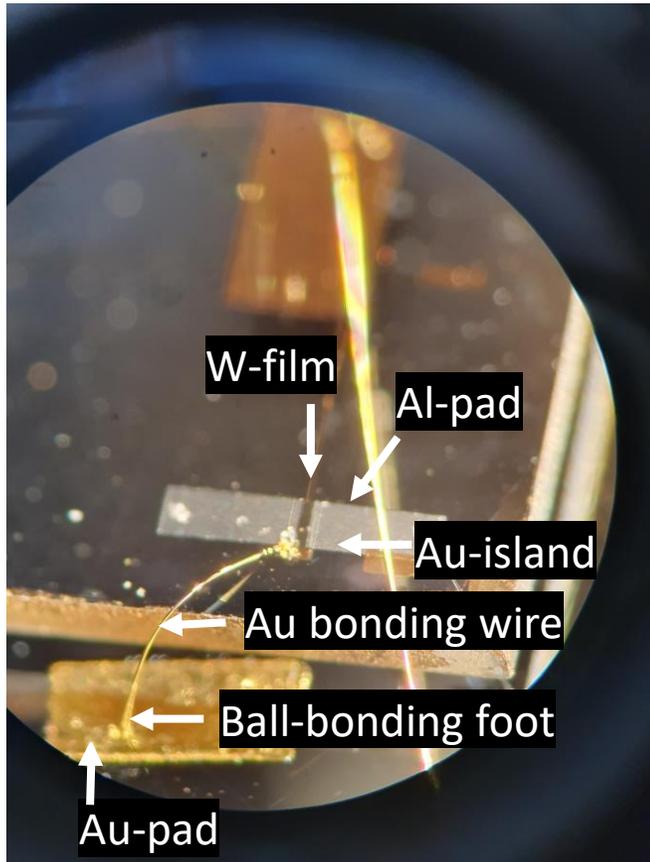


Detector Olympia

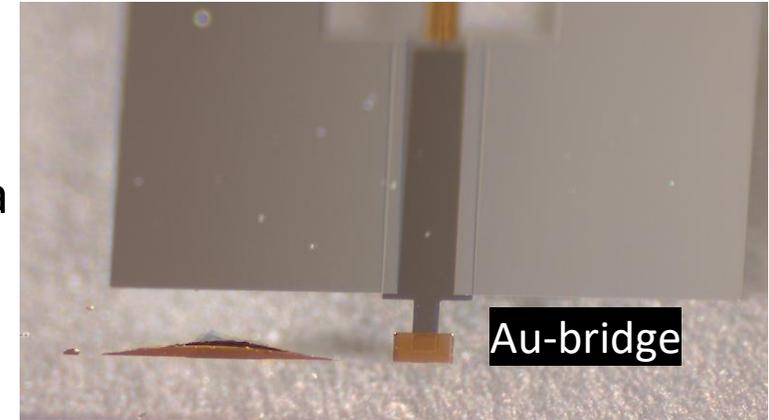


Detector Olympia'

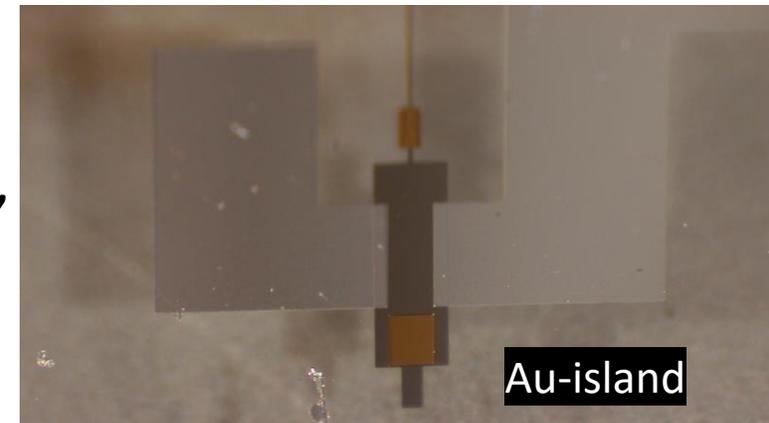
Modification: removal of the Au-bridge



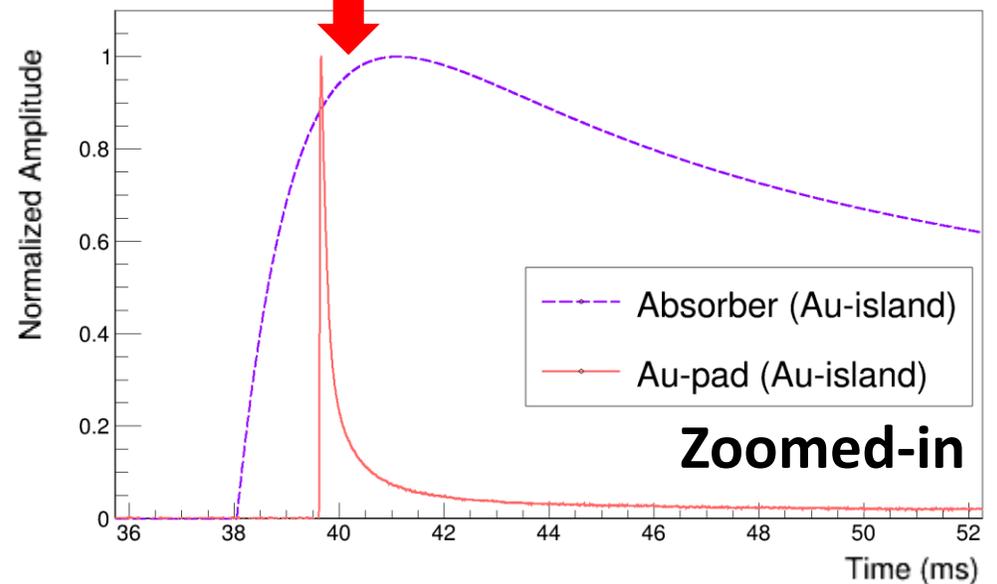
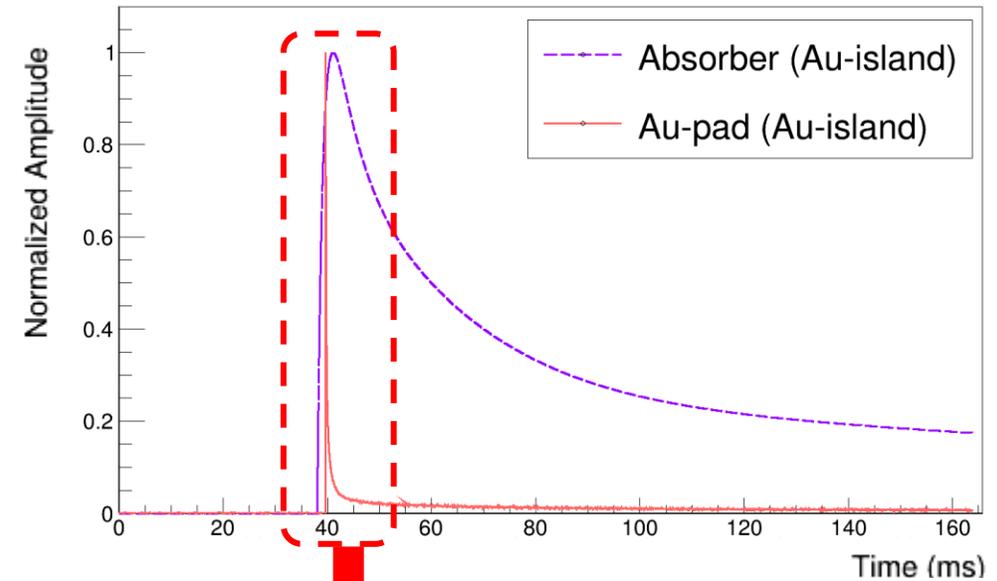
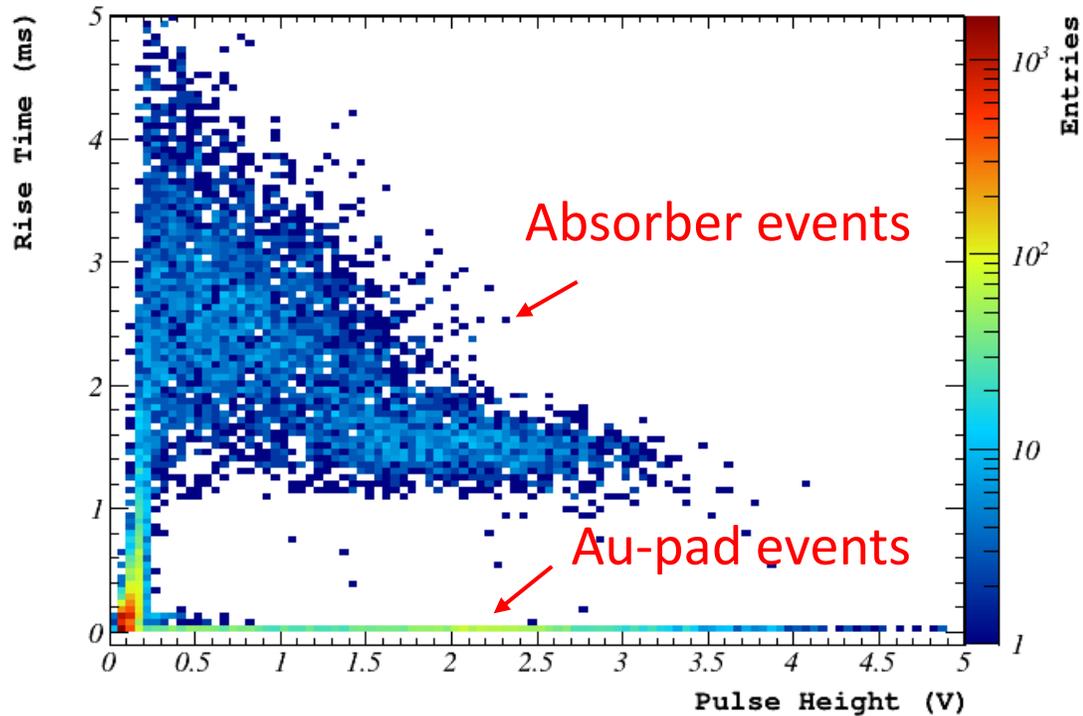
Olympia



Olympia'

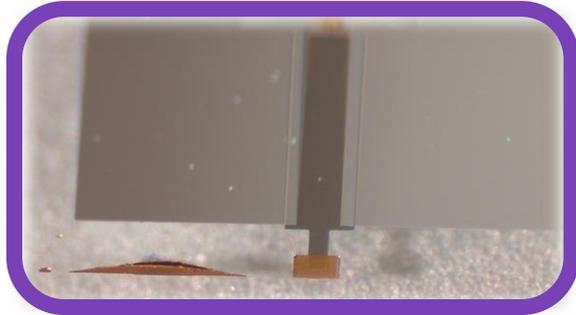


Detector Olympia'

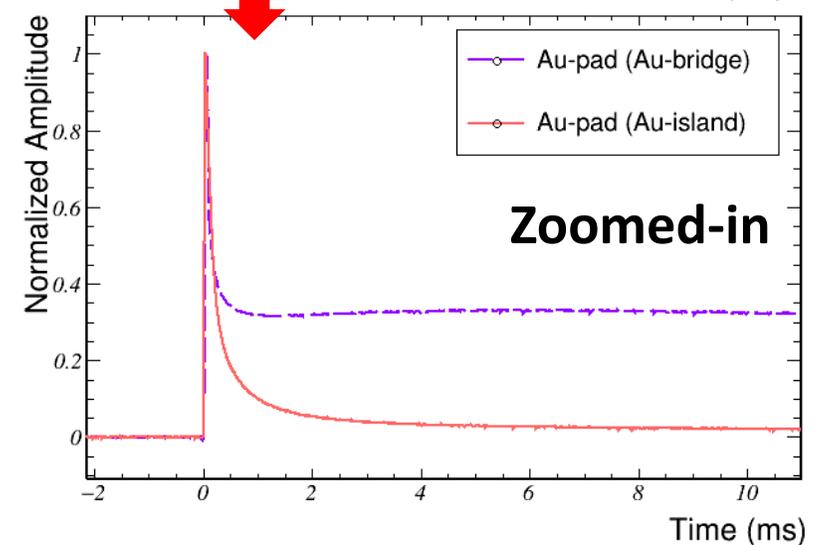
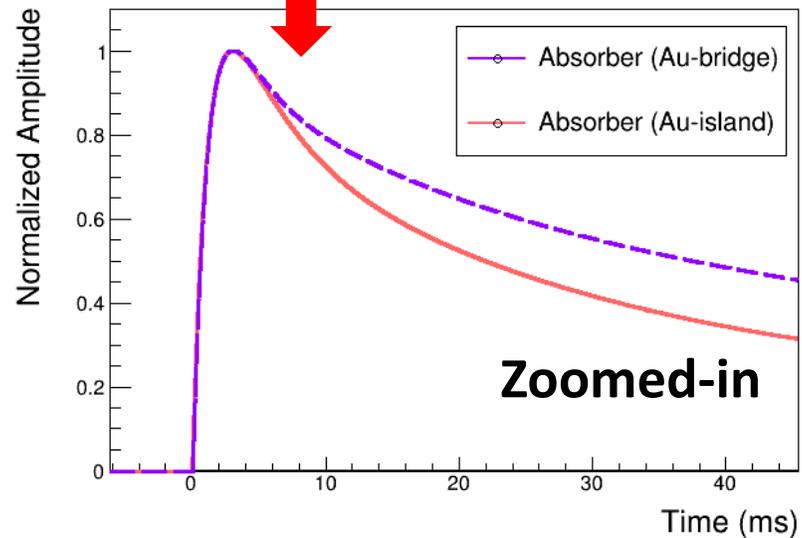
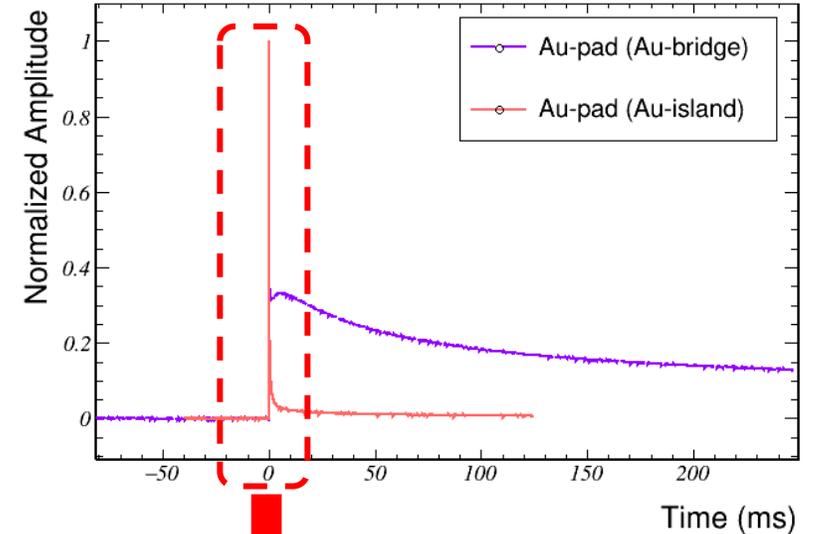
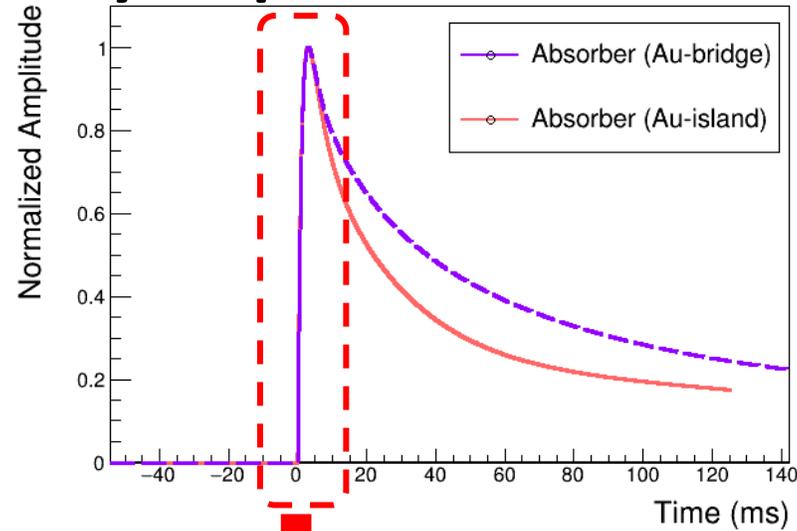
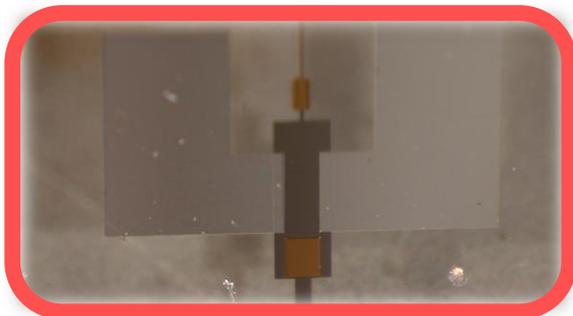


Olympia VS Olympia'

Au-bridge



Au-island



Detector Olympia'

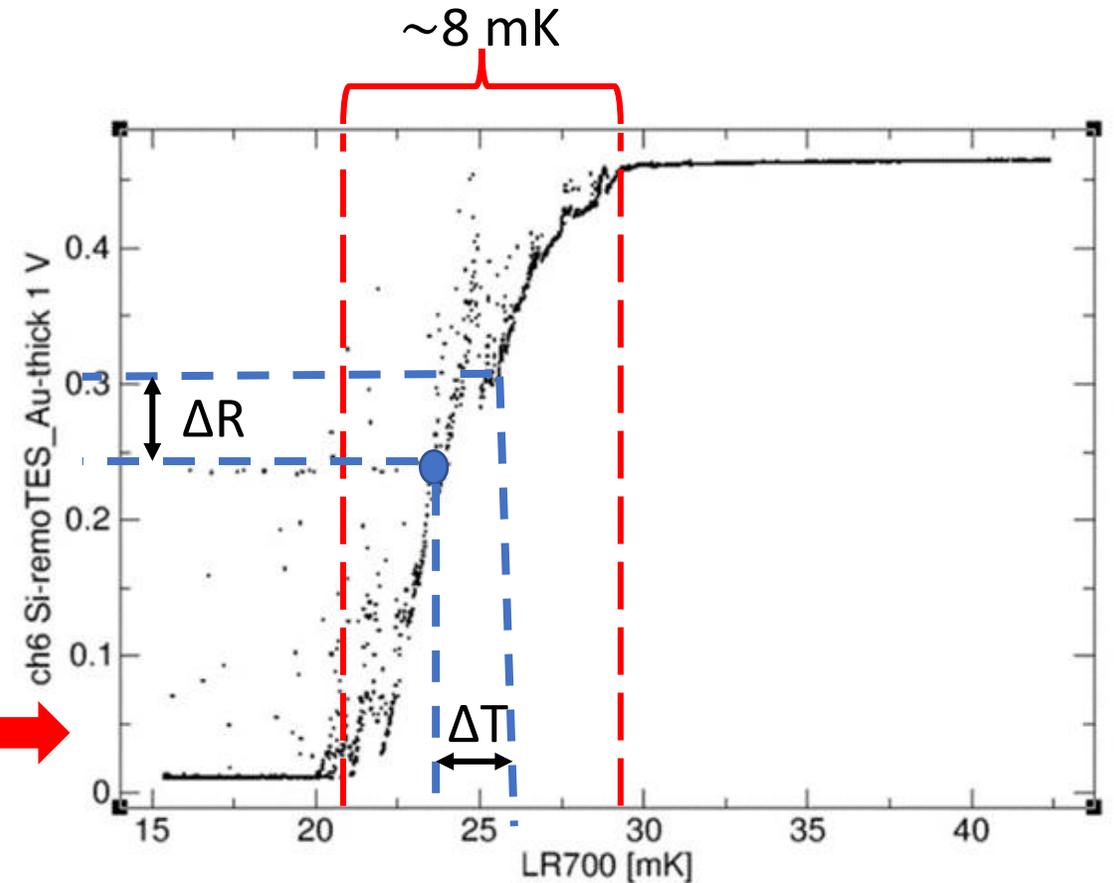
Modification: removal of the Au-bridge

Detector	Baseline resolution (eV)
Ψ	280±9
Φ	440±13
Electra	133±3
Olympia	89±2
Electra'	167±8
Olympia'	1159±134

Detector Olympia'

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Electra'	167 ± 8
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Conclusion

The remoTES offers possibilities for NaI/COSINUS but also other absorbers. In these studies it was found that:

- Wedge bonding tears the thin Au-foil
- Ball bonding improves the performance of the detector
- Heat capacity is not the limiting factor for the present detector design → best-achieved performance by Olympia
- Au-island leads to faster-decaying pulses

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Outlook

New COSINUS bonding machine!



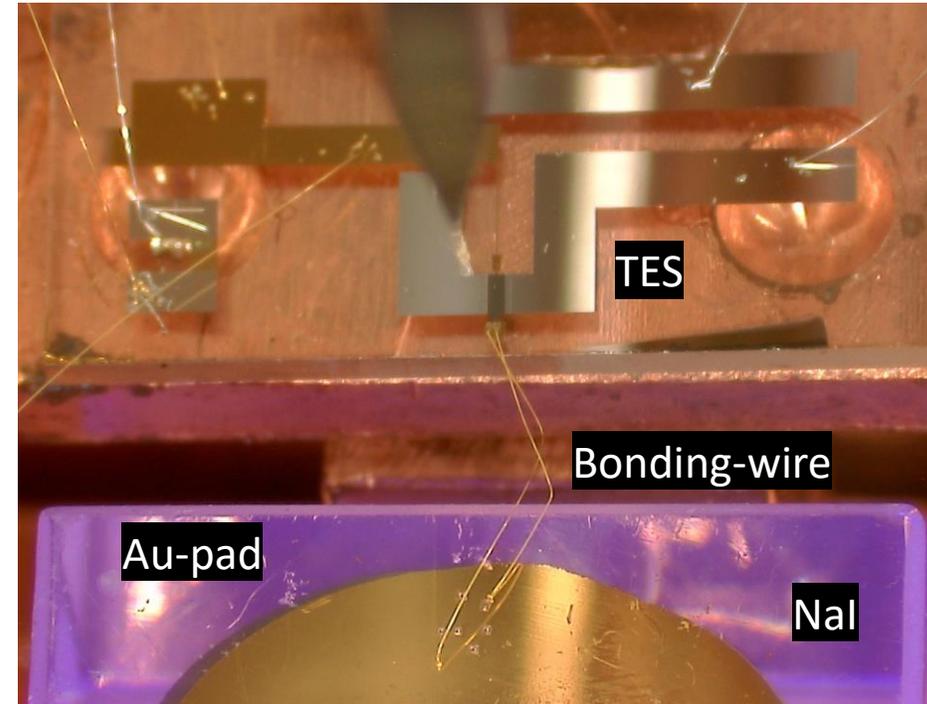
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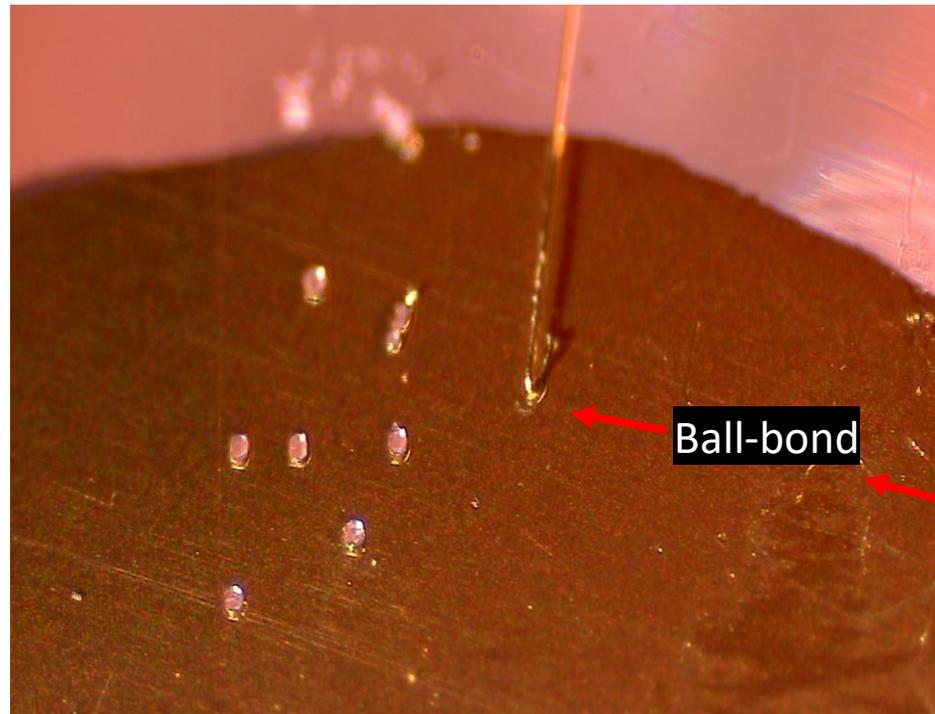
Outlook

Optimization studies applied to NaI!



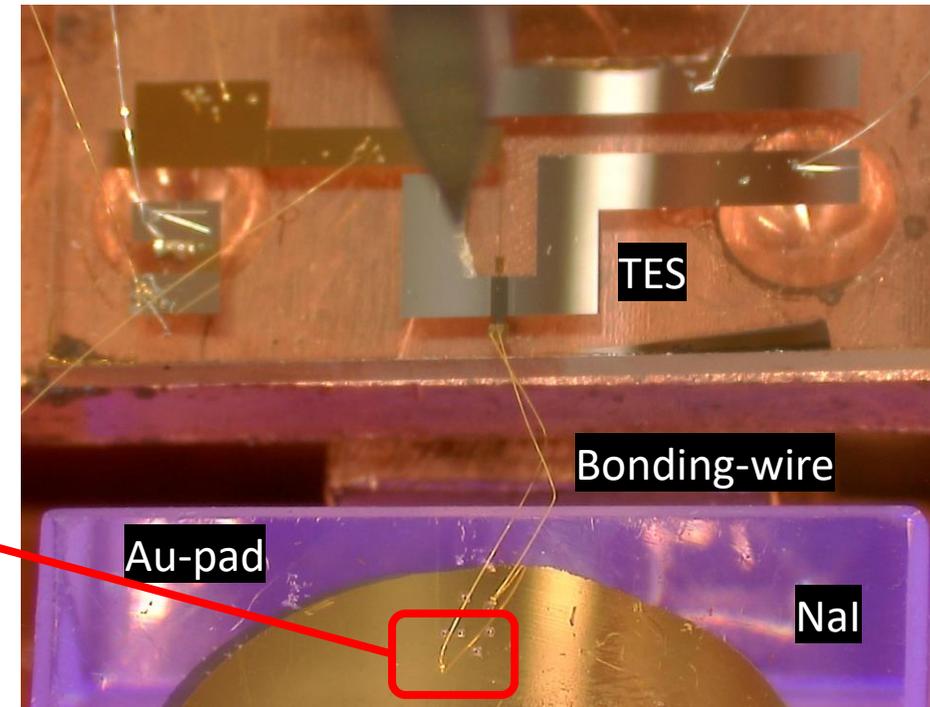
In collaboration with Rainer Götz, Aliaksandr Bandarenka TUM, TUM School of Natural Sciences, Department of Physics, Physics of Energy Conversion and Storage

Conclusion



Outlook

Optimization studies applied to NaI!



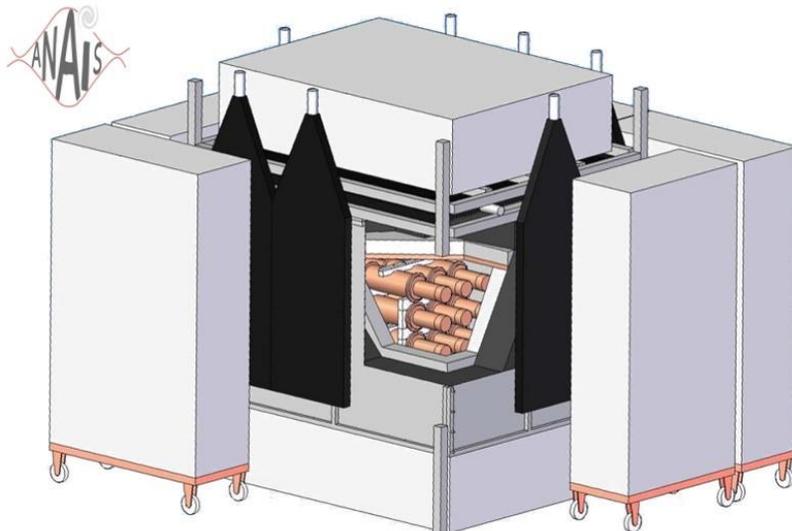
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 TUM, TUM School of Natural Sciences, Department of
 Physics, Physics of Energy Conversion and Storage

Thank you!

Other NaI experiments

ANAIS-112

- Room-temperature scintillator experiment
- Three years of data taking → exposure 313.95 kg × y
- No modulation observed
- Incompatible with DAMA/LIBRA results



<https://en.wikipedia.org/wiki/ANAIS-112>

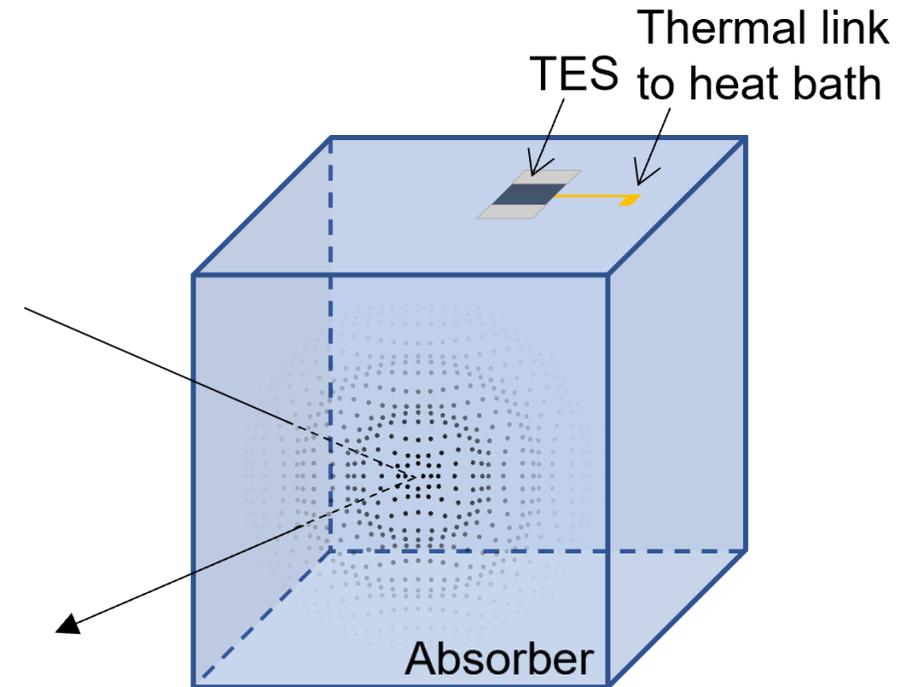
COSINE-100

- Room-temperature scintillator experiment
- Three years of data taking → exposure 173 kg × y
- Results consistent with both the DAMA-observed modulation and the case of no observed modulation



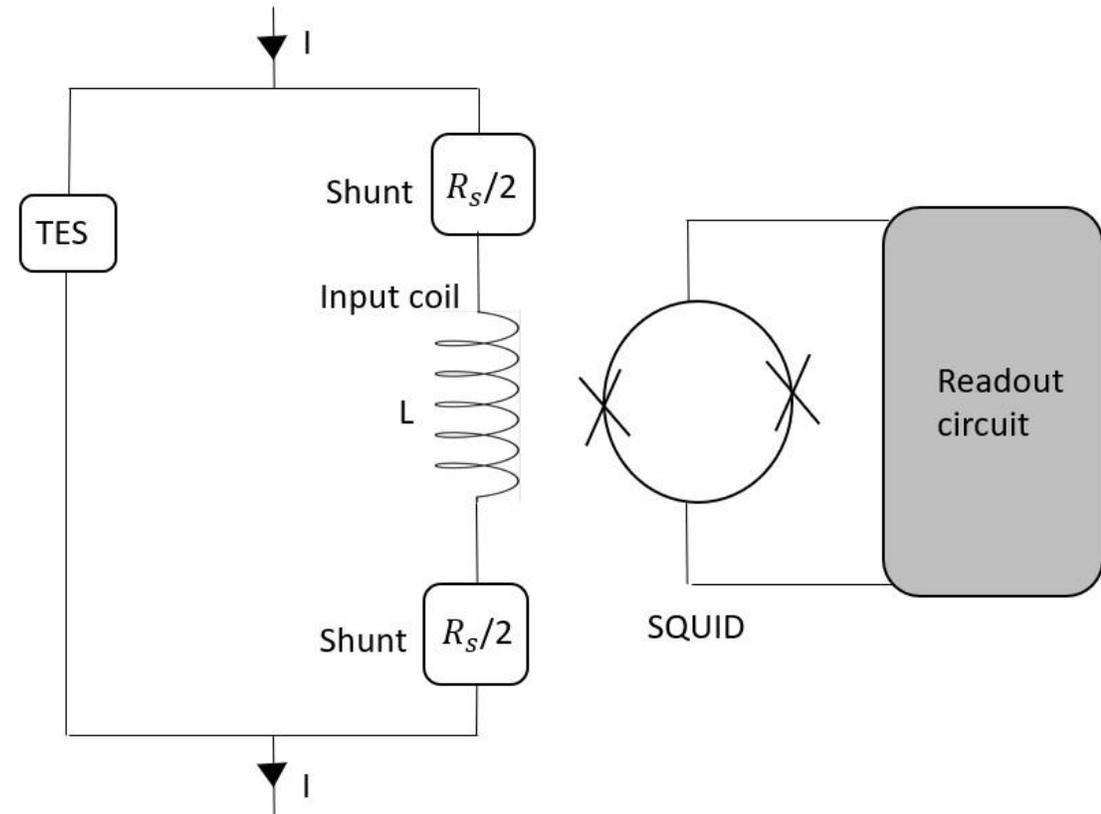
Cryogenic detectors

- Absorber weakly coupled to a thermal bath + temperature sensor
- Particle interaction produces atomic lattice vibration (phonons)
- The lattice vibrations cause a temperature increase in the absorber
- $\Delta T = \frac{\Delta E}{C}$
- Few keV energy deposition would cause a temperature increase of μK



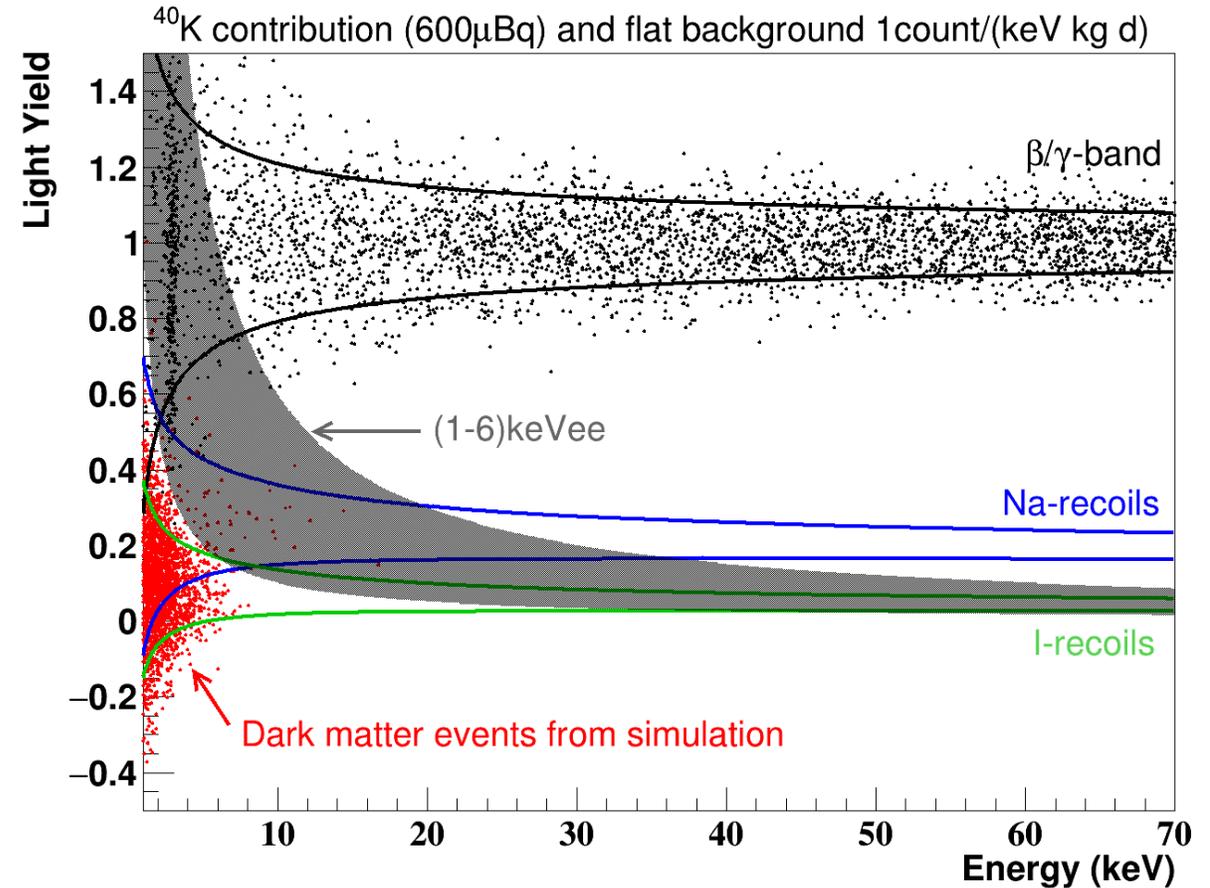
Read out circuit

- The TES connected in parallel with two shunt resistances
- A energy deposition induces a change in the resistance of the TES → change in the distribution of the current → change in the magnetic field induced by the input coil
- The change in the magnetic field is magnified and measured by the SQUID
- Output: pulse in voltage versus time

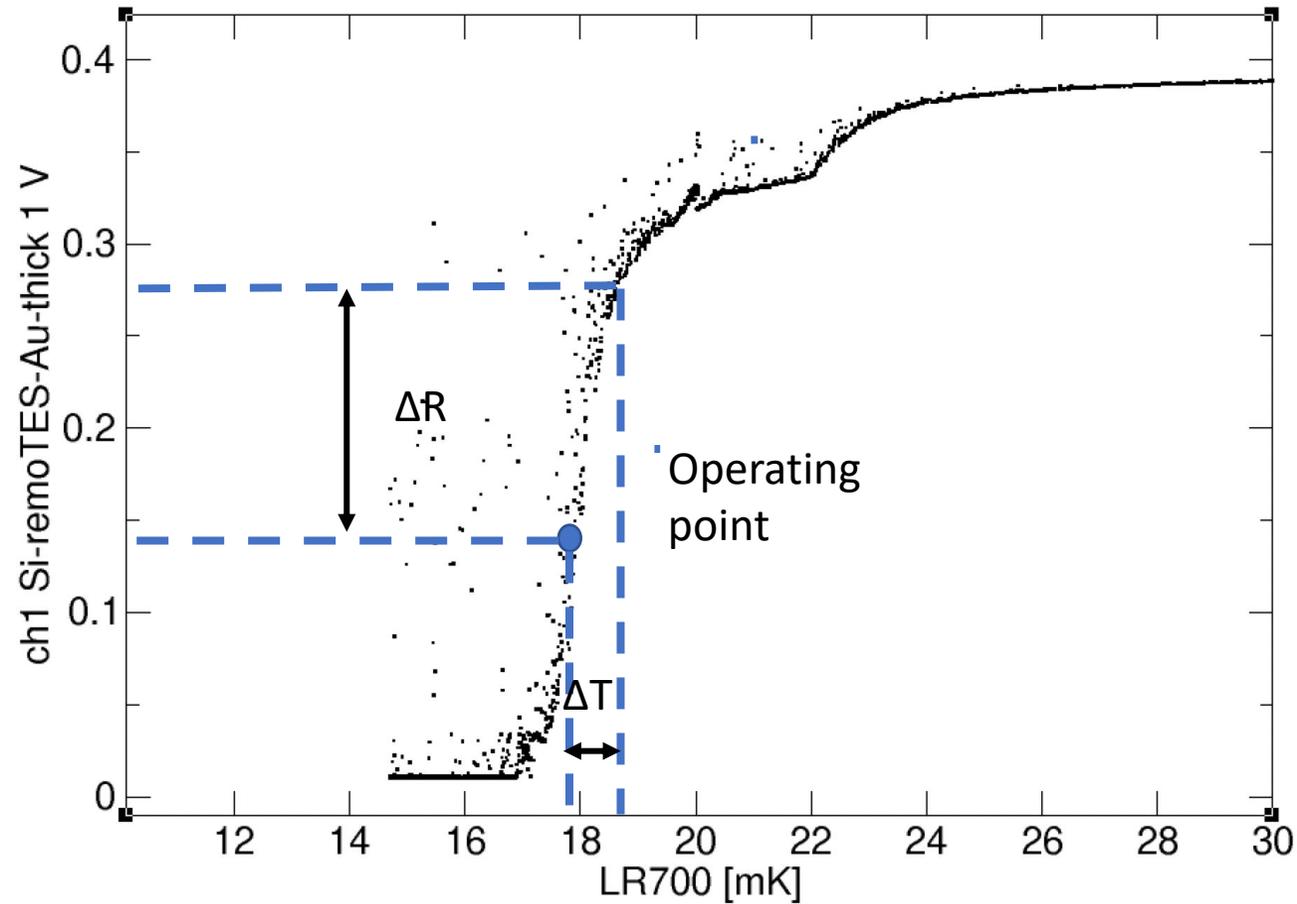


Light Yield

$$\text{LIGHT YIELD} = \frac{\text{LIGHT SIGNAL}}{\text{HEAT SIGNAL}}$$



Detector Olympia



Pulse shape analysis

The temperature increase in the thermometer can be described as:

$$\Delta T_e(t) = \Theta(t) \left[\underbrace{A_n \left(e^{-\frac{t}{\tau_n}} - e^{-\frac{t}{\tau_{in}}} \right)}_{\text{non-thermal component}} + \underbrace{A_t \left(e^{-\frac{t}{\tau_t}} - e^{-\frac{t}{\tau_n}} \right)}_{\text{thermal component}} \right]$$

- τ_n : lifetime of non-thermal phonons
- τ_{in} : intrinsic thermal relaxation time of the thermometer
- τ_t : relaxation time of the absorber

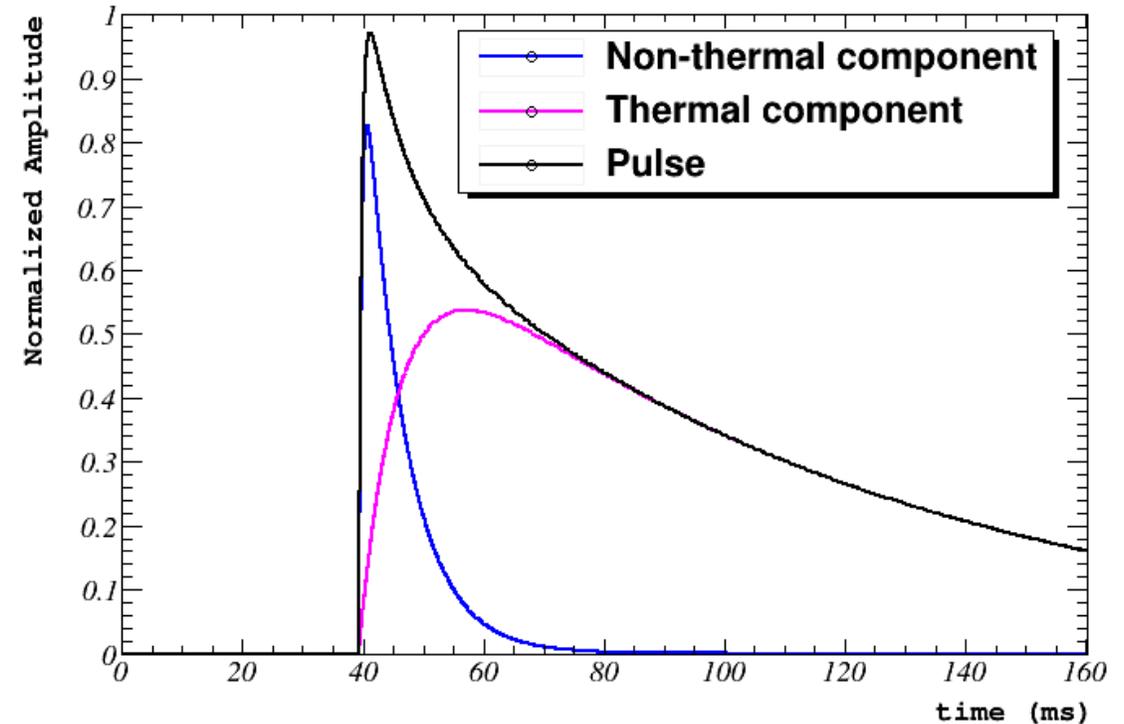
- $\tau_{in}/\tau_n \ll 1 \rightarrow$ **Bolometric Mode:**
 - τ_{in} : rise time of non-thermal
 - τ_n : decay time of non-thermal and rise time of thermal component
 - τ_t : decay time of the thermal component

- $\tau_n/\tau_{in} \ll 1 \rightarrow$ **Calorimetric Mode:**
 - τ_{in} : decay time of non-thermal
 - τ_n : rise time of non-thermal and thermal component
 - τ_t : decay time of the thermal component

Pulse shape analysis

Detector	Olympia
Event class	Absorber
A_n	1.11
A_t	0.73
τ_n	6.55
τ_{in}	0.51
τ_t	79.59

- For both detectors it holds that $\tau_{in}/\tau_n \ll 1$
 \rightarrow operated in the bolometric mode



Heat capacities

Detector	Electra ($\mu\text{J}/\text{K}$)	Olympia ($\mu\text{J}/\text{K}$)
Si crystal	$5.10 \cdot 10^{-6}$	$5.10 \cdot 10^{-6}$
Au-pad	$7.98 \cdot 10^{-6}$	$4.06 \cdot 10^{-5}$
Au-wire	$1.44 \cdot 10^{-6}$	$1.44 \cdot 10^{-6}$
Au-bond foot	$8.31 \cdot 10^{-8}$	$8.31 \cdot 10^{-8}$
Au-bridge/Au-island	$1.27 \cdot 10^{-6}$	$1.27 \cdot 10^{-6}$
TES	$9.78 \cdot 10^{-8}$	$9.78 \cdot 10^{-8}$
Total	$1.85 \cdot 10^{-5}$	$4.85 \cdot 10^{-5}$